

JEEC VARIATION AT DIFFERENT DIMENSIONS IN MILLIMETERS						N I E
S I M I L		A B D		T H I C K		
	MIN.	MIN.	MAX.			
A	μ	μ	1.20			13
A1	0.05	μ	0.15			
A2	0.95	1.00	1.05			
B		9.00 BSC.				4
D1		7.00 BSC.				
D		9.00 BSC.				7.8
E1		7.00 BSC.				
L	0.45	0.60	0.75			7.8
		64				
E		0.4 BSC.				9
b	0.13	0.18	0.23			
B1	0.13	0.16	0.19			
C	μ	μ	0.08			
C1	μ	μ	0.07			

10. CONTROLLING DIMENSION MILLIMETER
11. FANLY IS 0.98 MILLIMETERS
12. THIS OUTLINE CORRESPONDS TO JEPG PUBLICATION 95 REGISTRATION NS-056, VARIATION A9A, A9C, & A9D.
13. AS IS DENOTED AS THE DISTANCE FROM THE SEATING PLANE TO THE LATEST POINT OF THE PACKAGE BODY.
14. DIMENSION D2 AND E2 REPRESENT THE SIZE OF THE EXPOSED PAD, THE ACTUAL DIMENSIONS ARE SPECIFIED IN THE BONDING DIAGRAM, AND IS DEPENDENT ON THE DIE SIZE
15. EXPOSED PAD SHALL BE COPLANAR WITH BOTTOM OF PACKAGE WITHIN 0.051
16. CENTER CHAMFER OF EXPOSED DIE PAD SHALL BE WITHIN 0.20 MM.